S/N Unknown PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Song-Hua Shi et al.

Examiner:

Unknown

Serial No.:

Unknown

Group Art Unit:

Unknown

Filed:

Herewith

Docket:

884.698US2

Title:

UNDERFILL PROCESS FOR FLIP-CHIP DEVICE

Assignee:

**Intel Corporation** 

Customer No:

21186

## **INFORMATION DISCLOSURE STATEMENT**

MS Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Information Disclosure Statement considered.

Pursuant to 37 C.F.R. §1.98(d), copies of the listed documents are not provided as these references were previously cited by or submitted to the U.S. Patent Office in connection with Applicants' prior U.S. application, Serial No. 10/032115, filed on December 21, 2001, which is relied upon for an earlier filing date under 35 U.S.C. §120.

INFORMATION DISCLOSURE STATEMENT

Serial No :Unknown Filing Date: Herewith

Title: UNDERFILL PROCESS FOR FLIP-CHIP DEVICE

Assignee: Intel Corporation

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

SONG-HUA SHI ET AL.

By their Representatives,

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Date Feb. 6, 2004 By Com M. Mc Ceach.

Ann M. McCrackin Reg. No. 42,858

"Express Mail" mailing label number: <u>EV370238838US</u>

Date of Deposit: February 9, 2004

This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to the Commissioner for Patents, Mail Stop Patent Application, P.O. Box 1450, Alexandria, VA 22313-1450.

PTO/SB/08A(10-01)
Approved for use through 10/31/2002. OMB 651-0031
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Application Number	Unknown	
(Use as many sheets as necessary)	Filing Date	Even Date Herewith	
	First Named Inventor	Shi, Song-Hua	
	Group Art Unit	Unknown	
	Examiner Name	Unknown	
Sheet 1 of 1	884.698US2		

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Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T <sup>2</sup>

	OTHER DOCUMENTS NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s),	T²		
		publisher, city and/or country where published.			